

TOSHIBA SCHOTTKY BARRIER RECTIFIER SCHOTTKY BARRIER TYPE

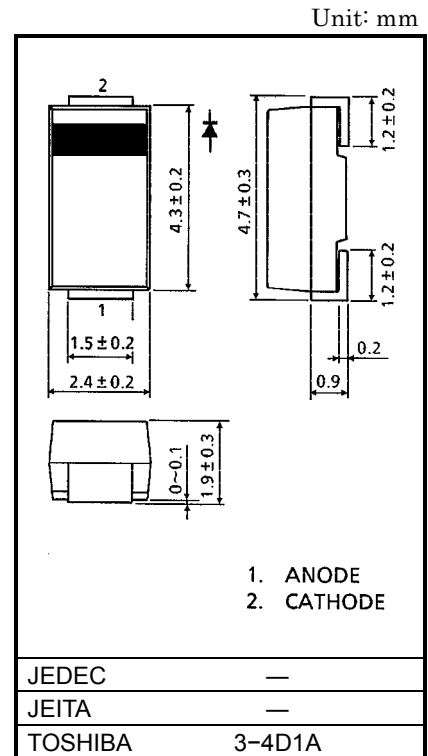
## U2FWJ44M

SWITCHING MODE POWER SUPPLY APPLICATION  
PORTABLE EQUIPMENT BATTERY APPLICATION

- Low Forward Voltage :  $V_{FM} = 0.45 \text{ V (Max)}$
- Average Forward Current :  $I_F (AV) = 2.0 \text{ A}$
- Repetitive Peak Reverse Voltage :  $V_{RRM} = 30 \text{ V}$
- Surface Mounting Plastic Mold Package

### MAXIMUM RATINGS ( $T_a = 25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	$V_{RRM}$	30	V
Average Forward Current	$I_F (AV)$	2.0	A
Peak One Cycle Surge Forward Current (Non-Repetitive)	$I_{FSM}$	60 (50Hz)	A
Junction Temperature	$T_j$	-40~125	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-40~125	$^\circ\text{C}$

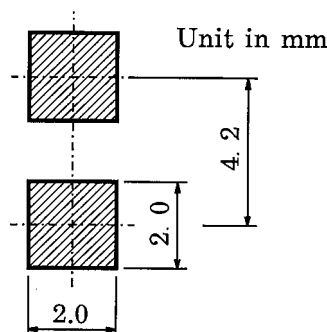


Weight: 0.06g

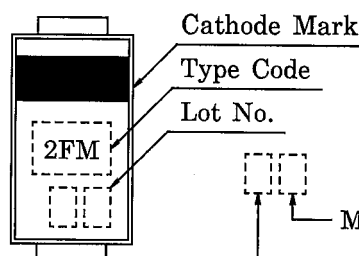
### ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Peak Forward Voltage	$V_{FM}$	$I_{FM} = 2.0 \text{ A}$	—	—	0.45	V
Repetitive Peak Reverse Current	$I_{RRM}$	$V_{RRM} = 30 \text{ V}$	—	—	500	$\mu\text{A}$
Junction Capacitance	$C_j$	$V_R = 10 \text{ V}, f = 1.0 \text{ MHz}$	—	125	—	pF
Thermal Resistance (Junction to Ambient)	$R_{th(j-a)}$	On ceramic substrate	—	—	60	$^\circ\text{C/W}$
		On glass-epoxy substrate	—	—	145	

### STANDARD SOLDERING PAD



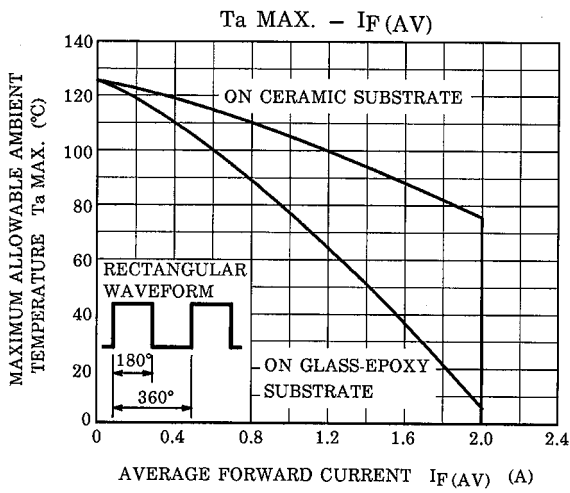
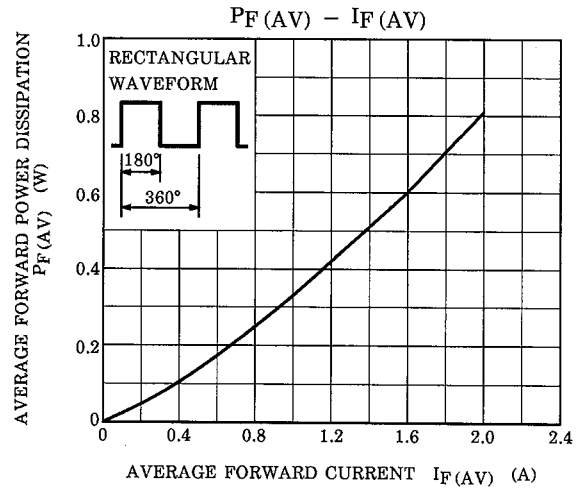
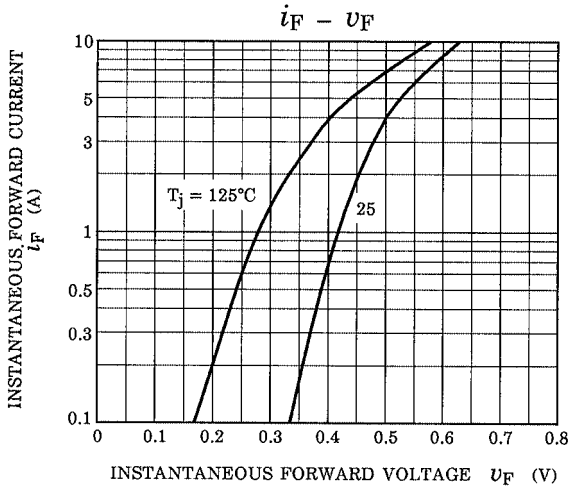
### MARKING



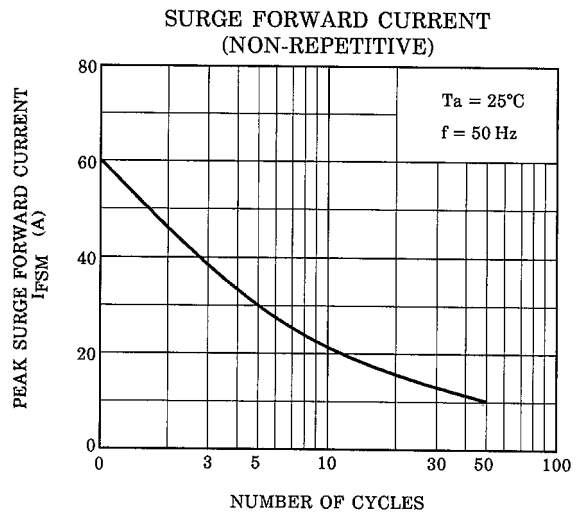
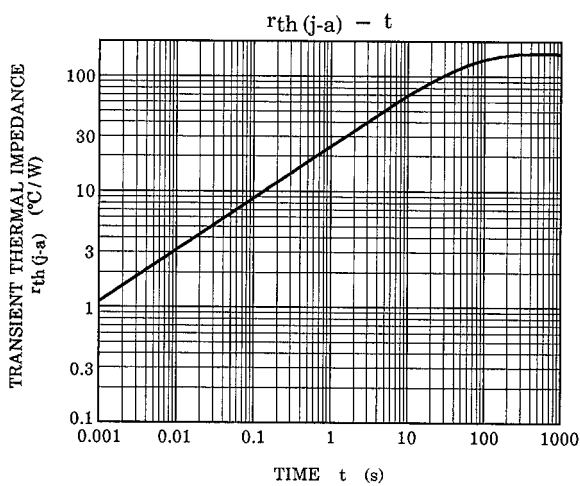
Code	Type
2FM	U2FWJ44M

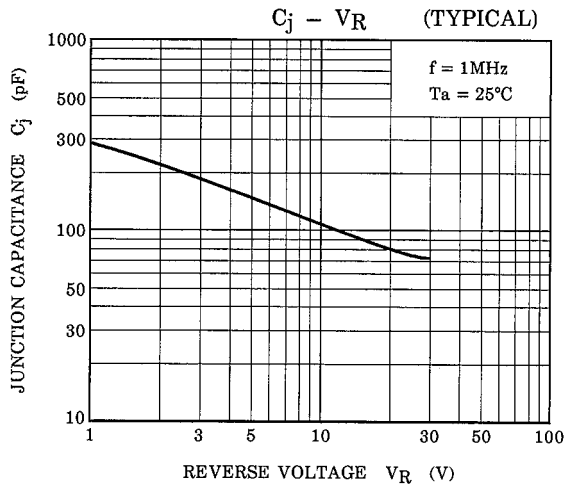
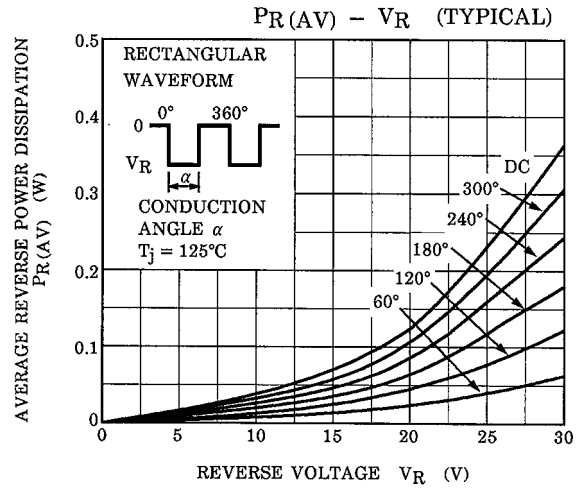
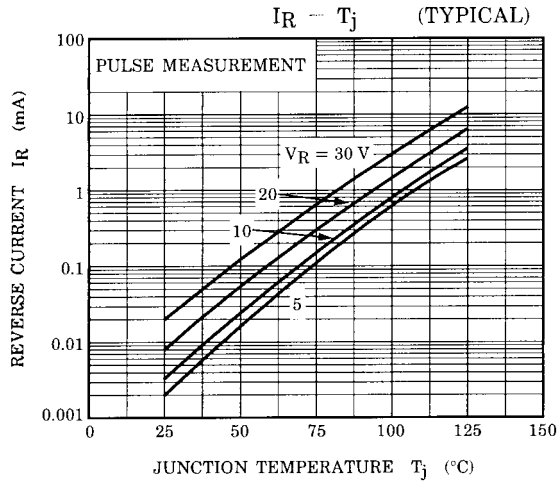
Month (Starting from Alphabet A)

Year (Last Number of the Christian Era)



	ON CERAMIC SUBSTRATE	ON GLASS-EPOXY SUBSTRATE
Soldering land : a	2 mm × 2 mm	6 mm × 6 mm
Substrate size : b	50 mm × 50 mm	50 mm × 50 mm
Substrate thickness : c	0.64 mm	1.6 mm





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000707EAA

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